LA HB19RP2

Premium Edition Hyper Blue 11 mil x 19 mil

Light Avenue Premium Edition LED series is designed for high performance consumer applications. Remarkable light extraction is reached by a particular top emitting design with vertical chip structure. As this die can be driven at very high currents compared to the chip size, an outstanding cost vs. performance ratio can be obtained.



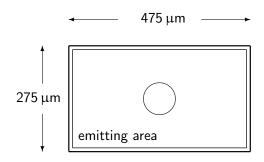
Features

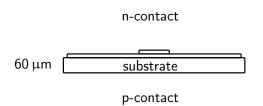
- Highest brightness InGaN chip
- Top emitting rectangular device
- Lambertian radiation
- Optimized for SMT applications
- Grouping: radiant power, wavelength

Applications

- Solid state lighting
- LCD backlighting
- Displays
- Light indicators
- Lamps

Delineation





Mechanical characteristics

DESCRIPTION		Minimum	$Typical^1$	Maximum		
Chip size	(µm)	250 x 450	275 x 475	300 x 500		
Chip height	(µm)	50	60	75		
Bond pad diameter	(µm)	80	90	100		
Top contact		Cathode (n), gold				
Bottom contact		Anode (p), gold alloy				
Die attach		Epoxy bonding				

LiGHT AVENUE®

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Electro-optical characteristics $(T_A=25^{\circ}\text{C})^2$

Parameter	Symbol	Condition	Min.	Typ. ¹	Max.	Unit
Forward voltage	V_F	$I_F=$ 20 mA	2.70		3.70	V
Reverse voltage	V_R	$I_R=$ 10 μA	5.0			V
Dominant wavelength	λ_{dom}	$I_F=$ 20 mA	440		457.5	nm
Radiant power	Φ_e	$I_F=$ 20 mA	16			mW

Maximum ratings $(T_A=25^{\circ}\mathrm{C})^3$

Parameter	Symbol	VALUE	Unit
Operating temperature range Forward current LED junction temperature	$T_{op} \ I_F \ T_j$	-40+85 50 125	mΑ

Binning $(I_F = 20 \,\mathrm{mA})^4$

		Wavelength (nm)					
		440-	442.5-	445-	447.5-	450-	452.5-
		445	447.5	450	452.5	455	457.5
	> 16	X19	XM19	Y19	YM19	Z19	ZM19
Radiant power (mW)	> 20	X20	XM20	Y20	YM20	Z20	ZM20
	> 25	X21	XM21	Y21	YM21	Z21	ZM21
	> 32	X22	XM22	Y22	YM22	Z22	ZM22

Notes:

- The usage of LEDs in life-support devices or systems has to be expressly and written authorized by the supplier!
- Dice are sensitive to ESD.
- Dice are shipped on blue foil with or without frame and have therefore to be stored between 15 and 30°C and below 60% relative humidity.
- Lead free product RoHS compliant.
- The information in this document is subject to change without notice and describes the die generally. It shall not be considered as assured characteristics or detailed specification.
- The quality level of the final visual inspection shall comply to an AQL of 1.0 (according to MIL-STD-105E, level II), if the customer performes an incoming visual inspection of a shipment.

LIGHT AVENUE®

$LA~HB19RP2 \qquad \text{Premium Edition Hyper Blue 11 mil} \times 19~\text{mil}$

 All chips are checked according to the "Failure Catalog of Light Avenue dice" dated 2009-11-14. If this document is not familiar to you, please request it at your next sales office.

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¹Typical (Typ) data are defined as long-term production mean values. These values are not specified and only given for information.

 $^{^2}$ Measurements are done with an accuracy of $\pm 15\%$. Correlation to customer's equipment and products is required.

³Maximum ratings are package dependent and may differ between packages. The forward current is not limited by the die but by the effect of the LED junction temperature on the package. If you need more information on pulsed operation, please contact your next sales office about possible driving conditions. If not otherwise specified the maximum pulse current may not exceed the maximum current in continuous mode.

⁴There may be more than one bin on one single foil. Single bins cannot be ordered.